1. Disassembly Procedures

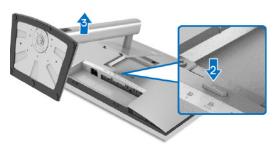
S1 Turn off power

S2 To remove the stand

Place the monitor on a soft cloth or cushion

Press and hold the stand release button

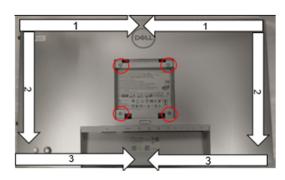
Lift the stand up and away from the monitor



S3 Unlock 4 screws on Rear Cover

Use hands or scraper bar to disassemble Rear Cover from monitor

Notice the disassembly order:
Top Side=>Right/ Left Side=>Bottom
Side



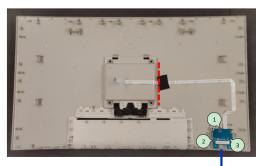
(Screw Torque: 8-10Kgf)

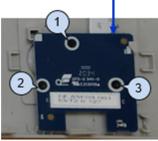
Pull out CTRL BD FFC from I/F BD and tear off it from Main SHD to take off Rear Cover



S5 Tear off a tape from CTRL BD FFC and Rear Cover

Unlock screw*3 to disassemble CTRL BD from Rear Cover

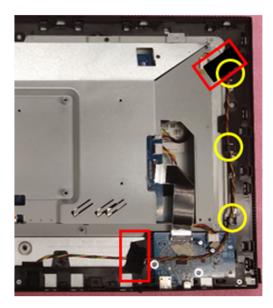




(Screw Torque: 0.9-1.0Kgf)

S6 Tear off 2 tapes from Backlight wire

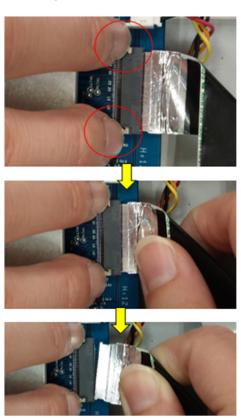
Pull out Backlight wire from LED Driver BD



Press on the lock of connector to disassemble USB FFC from I/F BD

Attention:

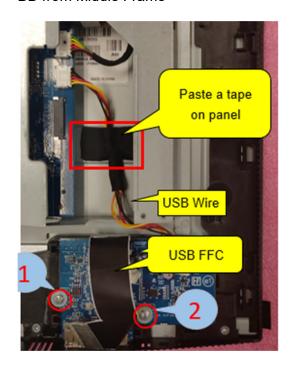
USB FFC may be damaged if you pull out it from I/F BD directly without pressing the lock



S8 Tear off a tape from USB wire

Pull out USB wire from I/F BD

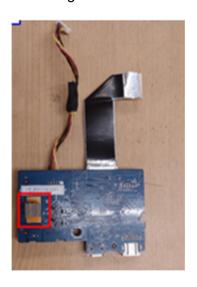
Unlock 2 screws to disassemble USB BD from Middle Frame



(Screw Torque: 4.5±0.5Kgf)

S9 Pull out USB wire and USB FFC from USB BD

Take off gasket from USB BD



S10 Disassemble LVDS FFC cable from Panel

Take off Main SHD from panel



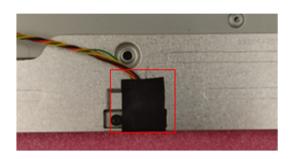
S11 Unlock 14 screws to disassemble Middle Frame



(Screw Torque: 5.0±0.5Kgf)

S12 Tear off a tape from Backlight wire and panel

Pull out Backlight wire from panel



S13 Disassemble 5 plastic BOSS from panel



\$14 Disassemble mylar from Main SHD



S15 Unlock 10 PCBA screws to disassemble I/F BD, SPS BD and LED Driver BD from Main SHD



(Screw Torque: 8.5±1Kgf)

Remove all cables from I/F BD, SPS BD and LED Driver BD



Remove electrolyte capacitors (red mark) from printed circuit boards



S17

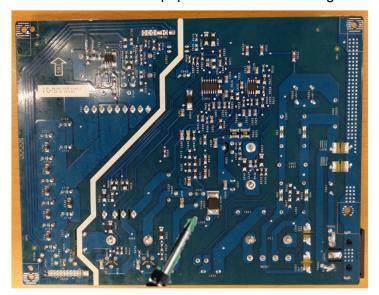
S17-1 Cut the glue between bulk cap. and PCB with a knife



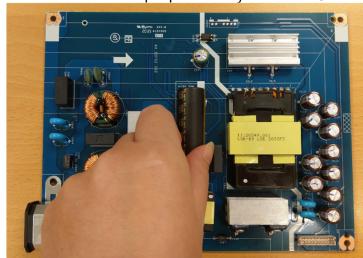
S17-2 Ensure cutting path within the glue, don't touch bulk cap. or PCB



S17-3 Take out bulk cap. pin solder with soldering iron and absorber



S17-4 Lift the bulk cap. up and away from the PCB



2. Product material information

The following substances, preparations, or components should be disposed of or recovered separately from other WEEE in compliance with Article 4 of EU Council Directive 75/442/EEC.

Capacitors / condensers (containing PCB/PCT)	No used
Mercury containing components	No used
Batteries	No used
Printed circuit boards (with a surface greater	Product has printed circuit boards
than 10 square cm)	(with a surface greater than 10 square
	cm)
Component contain toner, ink and liquids	No used
Plastic containing BFR	No used
Component and waste contain asbestos	No used
CRT	No used
Component contain CFC, HCFC, HFC and	No used
HC	
Gas discharge lamps	No used
LCD display > 100 cm2	Product has an LCD greater than 100
	cm2
External electric cable	Product has external cables
Component contain refractory ceramic fibers	No used
Component contain radio-active substances	No used
Electrolyte capacitors (height	Product has electrolyte capacitors
> 25mm, diameter > 25mm)	(height >25mm, diameter > 25mm)

3. Tools Required

List the type and size of the tools that would typically can be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description:

- Screwdriver
- Penknife
- Bar scraper